The present invention relates to solid delay line improvements and particularly to the production of ferroelectric ceramic transducers that may be readily bonded in known manner for operation in the shear mode to a non-crystalline solid delay line medium and to a back electrode, such for example as a delay line composed of glass or fused silica, and a back electrode composed of a tin-lead alloy.

The industry has for some time employed ferroelectric ceramic transducers mounted for longitudinal mode of vibration on delay lines designed for short delay time periods. On longer lines such transducers have been similarly mounted, and in the absence of knowledge as to how to directly mount the ceramic transducers for shear mode vibration, have resorted to the use of mode conversion prisms. In general, for longer lines with many reflection paths the thickness shear mode of vibration of quartz has been found satisfactory. Some of the advantages gained by use of ferroelectric ceramic transducers operating in the thickness shear mode, however, are low attenuation of the main signal, high attenuation of the unwanted third time spurious signal, and utilization of low cost optical glass for short delay lines instead of the high cost silica required when quartz transducers are employed. Moreover, ceramic transducer assemblies are thermally stable and more readily reproducible than are quartz transducers. They also have the further advantage of low insertion loss compared to quartz.

The fact that ceramic transducers must not be subjected to temperatures exceeding 200° C. for any appreciable time after their polarization, has heretofore prevented their employment in the shear mode for lack of a low temperature method of applying a solderable coating thereto. Although such a temperature is exceeded by application thereto of a solderable film by conventional methods, this has been no handicap in the production of transducers polarized for the longitudinal mode. Under these circumstances the surface to be united with the delay line medium are merely disposed of and the second layer of about 500 angstroms of chromium is then deposited by vacuum evaporation at room temperature. The purpose of this metal, which is insoluble in solder, is to serve as a barrier between the solder and the transducer and the back electrode are swabbed with a fiber glass brush tinned with 65% In-35% Sn solder, mated, and then

layer of chromium, a layer of an alloy which is approximately 80% Ni and about 20% Cr laid down in a manner that produces a gradient coating in which the Cr content is the highest at the start and lowest at the end of the coating period respectively, and finally depositing a layer of Au thereon.

For a more detailed description of the invention reference is made to the accompanying drawing wherein:

FIG. 1 is a perspective representation of a polarized block of ferroelectric ceramic material.

FIG. 2 is an exploded view, in side elevation, diagrammatically depicting the ceramic transducer and its respective coatings arranged between a back electrode and the coating of a facet of a delay line; the bonding materials for effecting union of the transducer with the back electrode and with the facet coating also being shown.

Referring to the drawing in detail, the block of material 11 has conductive coatings 12 and 13 on its upper and lower surfaces respectively which have previously been connected to the terminals of a high voltage direct current source to impart to it a poling axis transversely therethrough, as indicated by the arrows A, so that when a slice such as 15 is removed therefrom for use as a transducer and one of its broad sides mated with a delay line surface, it will be in shear mode relation thereto.

Specifically, the first or base layer of about 300 angstroms of platinum or silver is deposited on both sides of the slice 15 of the ceramic by vacuum evaporation at room temperature. This coating is preferably baked in an open atmosphere at a temperature of approximately 200° C. for from one to eighteen hours to provide good adherence.

The second layer of about 500 angstroms of chromium is then deposited by vacuum evaporation at room temperature.

The purpose of this metal, which is insoluble in solder, is to serve as a barrier between the solder and the platinum, which is soluble.

The third layer of about 500 angstroms of a nickel-chrome alloy containing approximately 80% Ni and 20% Cr is also applied at room temperature by the evaporation process in the vacuum maintained during application of the second layer.

The fourth or final layer of about 500 angstroms of gold is applied in the vacuum maintained during application of the third layer to preserve the nickel-chrome's metallic surface.

In effecting unions with the delay line medium and with the back electrode respectively, the final layers of gold are almost instantly dissolvable by the solders employed. During such a soldering operation the solder penetrates the multi-layer coatings until it is stopped either at the high Cr part of the nickel-chrome layer or at the nickel-chrome Cr interface.

As indicated in FIG. 2, the delay line bears a layer of platinum on its transducer mating facet 20. Fusion of its surface to the gold surface of 15 is effected by direct heat into the mating surfaces until they reach a temperature of 200° C. or thereabout and puddling pure indium thereon. Such surfaces are then swabbed with a vibrating fiber glass brush, tinned with pure indium from an auxiliary molten puddle thereof and the indium slowly spread over the respective mating surfaces substantially as described in the French patent. The respective surfaces are then permitted to cool down to a stabilized temperature of between 165°-175° C. and after a final skin removal from such surfaces they are brought together into aligned contact and subjected to gradually increased pressure until cooled to approximately 135° C.

At this point, the mating surface of the transducer and the back electrode are swabbed with a fiber glass brush tinned with 65% In-35% Sn solder, mated, and then
allowed to cool. The back electrode preferably is a pre-formed block of 60% tin-40% lead, as in the referred-to patent and application.

Surplus solder is removed from the finished assembly with a sharp knife or razor blade. Any of the evaporated coating material on the external surfaces is readily removed by dental sand blasting equipment.

Although union between applicants' ferroelectric transducer with a delay line and a tin-lead back electrode is substantially in accordance with the teaching of the referred-to French patent, as briefly described above, a quite, obviously similar unions may be effected by use of any solder having a high indium content. The ferroelectric ceramic material employed by applicants is approximately 45% PbTiO₃-55% PbZrO₂, but it is believed applicants' techniques are equally applicable to other ferroelectric ceramic compositions.

What is claimed is:

1. The method of preparing surfaces of a transducer for solderable union with a solid delay line and its back electrode which comprises application to each of its two broad surfaces a base coat of a noble metal by vacuum deposition, depositing a layer of chromium on said base coat, overlaying the chromium with a gradient coating containing approximately 80% Ni and 20% Cr with the content of Cr being highest at the chromium interface and lowest at the exposed surface, and finally overlaying the gradient coating with a layer of gold.

2. The method of coating a transducer with a material solderable at a temperature of approximately 200° C., which comprises applying by vapor deposition in a vacuum successively and at temperatures under 200° C., films of the followin gmetallic materials: a noble metal, chromium, a nickel-chromium alloy containing approximately 80% Ni and 20% Cr laid down in graded composition in which the Cr content is highest at the start and lowest at the completion of evaporation, and gold.

3. A method such as defined by the preceding claim which includes baking the noble metal coating at a temperature of approximately 200° C., for a substantial time period.

4. In a ferroelectric ceramic transducer, having on a surface thereof parallel to its poling axis a coating through the medium of which it is solderable to an indiumized mating facet of a delay line and a back electrode at a temperature below that at which the polarization of such transducer would be adversely affected said coating comprising layers of a noble metal, chromium, nickel-chrome and gold arranged thereon in the order named.

5. A ferroelectric ceramic transducer such as defined by claim 4 wherein the noble metal comprises silver.

6. A ferroelectric ceramic transducer such as defined by claim 4 wherein the noble metal comprises platinum.

References Cited in the file of this patent

UNITED STATES PATENTS

2,672,590 McSkimin Mar. 16, 1954
2,702,427 Roberts Feb. 22, 1955
2,731,573 Hansen et al. Jun. 17, 1956
2,767,336 Arenberg Oct. 16, 1956
2,777,997 Arenberg et al. Jan. 15, 1957
2,787,520 Meiners et al. Apr. 2, 1957
2,859,415 Fagen Nov. 4, 1958

OTHER REFERENCES